Vishay Draloric



Thin Film Mini-MELF Resistors



FEATURES



- · AEC-Q200 qualified
- Low TCR and tight tolerances
- Excellent stability in different environmental conditions
- Pure tin termination on nickel barrier, plated on press fit steel caps
- Compliant to RoHS Directive 2002/95/EC





RoHS COMPLIANT

<u>GREEN</u> (5-2008)**

STANDARD ELECTRICAL SPECIFICATIONS									
MODEL	POWER RATING P ₇₀ W	LIMITING ELEMENT VOLTAGE DC or AC _{RMS} V	TEMPERATURE COEFFICIENT ppm/K	TOLERANCE %	$\begin{array}{c} \textbf{RESISTANCE} \\ \textbf{RANGE} \\ \Omega \end{array}$	E-SERIES			
SMM0204	0.25	200	± 15	± 0.1 ± 0.25 ± 0.5	43R to 221K 22R to 221K 10R to 221K	24; 96; 192			
SMM0204	0.25	200	± 25	± 0.1 ± 0.25 ±0.5	43R to 511K 22R to 511K 10R to 1M0	24; 96; 192			
SMM0204	0.25	200	± 50	± 0.5 ± 1	10R to 1M0 R82 to 10M	24; 96; 192 24; 96			
SMM0204	0.25	200	± 100	± 5	R22 to 10M	24			
Zero-Ohm-Resistor: OMM0204 $R_{\text{max.}} = 10 \text{ m}\Omega$ $I_{\text{max.}} = 3 \text{ A}$									

Notes

- SMM0204 EN803 E0 and OMM0204 EN803 E0 respectively are available versions with IECQ-CECC approval to EN 140401-803, version A, with nominal failure rate level E0.
- The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.

TECHNICAL SPECIFICATIONS							
PARAMETER	UNIT	SMM0204					
Power rating P ₇₀	W	0.25					
Limiting element voltage, DC or AC _{RMS}	V	200					
Insulation voltage (1 min), DC or AC _{PEAK}	V	300					
Insulation resistance	Ω	≥ 10 ¹⁰					
Category temperature range	°C	- 55 to + 125 (+ 155)					
Failure rate: FIT _{observed}	≤ 0. ⁻	I x 10 ⁻⁹ /h					

Notes

- The upper temperature limit of 125 °C reflects the prescriptions of the detail specification EN 140401-803. However, the products may be
 operated up 155 °C, if the tradeoff through decreased drift stability is acceptable to the specific application.
- The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the
 printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 125 °C or 155 °C respectively
 is not exceeded.
- The specification of this product is based on a test board according to EN 140400, providing a thermal resistance of approximately 220 K/W.
- These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over
 operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.
- The IECQ-CECC approved product versions SMM0204 EN803 E0 and OMM0204 EN803 E0 respectively feature a quality factor $\pi_Q = 3$ for the purpose of system MTBF calculations, compared with $\pi_Q = 10$ for the standard versions.

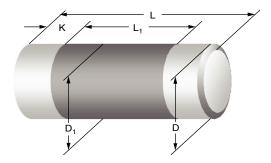
Document Number: 20004 Revision: 16-Sep-11

^{**} Please see document "Vishay Material Category Policy": www.vishay.com/doc?99902



Thin Film Mini-MELF Resistors

DIMENSIONS

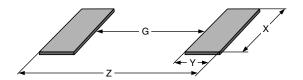


DIMENSIONS AND MASS								
ТҮРЕ	L (mm)	D _{max.} (mm)	L _{1 min.} (mm)	D ₁ (mm)	K (mm)	MASS (mg)		
SMM0204 OMM0204	3.6 + 0/- 0.15	1.4	1.75	D + 0/- 0.15	0.85 + 0/- 0.35	18		

Notes

- Color code marking is applied according to IEC 60062 in four bands for 5 % tolerance, or in five bands. Each color band appears as a single solid line, voids are permissible if at least ²/₃ of the band is visible from each radial angle of view. The last color band for tolerance is approximately 50 % wider than the other bands.
- The color of the body coating is light green for jumpers and for a temperature coefficient of ± 50 ppm/K or of ± 100 ppm/K, pink for ± 25 ppm/K, or violet for ± 15 ppm/K.
- · Zero ohm jumper are marked with one centered black band.

PATTERN STYLES FOR MELF RESISTORS



RECOMMENDED SOLDER PAD DIMENSIONS									
ТҮРЕ	WAVE SOLDERING				REFLOW SOLDERING				
	G (mm)	Y (mm)	X (mm)	Z (mm)	G (mm)	Y (mm)	X (mm)	Z (mm)	
SMM0204 OMM0204	1.5	1.5	1.8	4.5	1.6	1.25	1.7	4.1	

Note

• The given solder pad dimensions reflect the considerations for board design and assembly as outlined e.g. in standards IEC 61188-5-x, or in publication IPC-7351. They do not guarantee any supposed thermal properties, however, they will be found adequate for most general applications.

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PART NUMB	ER AND PRODUCT	DESCRIPTION			
	M02040C5620FB000				
Part Number: OM S M O M MODEL SMM0204 OMM0204	M02040000000B000 M 0 2 0 VERSION 0 = Neutral V = EN 140401-803, version A, nominal failure rate level E0	4 0 C 5 4 0 0 0 TCR E = ± 15 ppm/K D = ± 25 ppm/K C = ± 50 ppm/K B = ± 100 ppm/K 0 = Jumper			0 0 0 PACKAGING B1 B3 B0 M3
•	ion: SMM0204 50 562R 1 % ion: OMM0204 0R0 B0	В0	$0 = *10^{0}$ $5 = *10^{5}$ $1 = *10^{1}$		
SMM0204	50	562R	1 %	В0	-
OMM0204	-	0R0	-	ВО	-
MODEL	TCR	RESISTANCE	TOLERANCE	PACKAGING	VERSION
SMM0204 OMM0204	± 15 ppm/K ± 25 ppm/K ± 50 ppm/K ± 100 ppm/K	100R = 100 Ω 2M21 = 2.21 MΩ 0R0 = Jumper	± 0.1 % ± 0.25 % ± 0.5 % ± 1 % ± 5 %	B1 B3 B0 M3	

Note

• Products can be ordered using either the PART NUMBER or the PRODUCT DESCRIPTION.

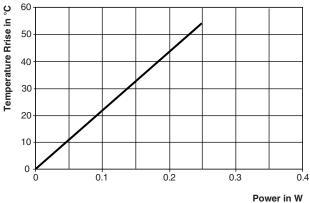
PACKAGING								
TYPE	CODE	QUANTITY	CARRIER TAPE	WIDTH	PITCH	REEL DIAMETER		
SMM0204 OMM0204	B1 ⁽¹⁾	1000 (1)	Blister tape acc. IEC 60286-3	8 mm	4 mm	180 mm/7"		
	В3	3000						
	В0	10 000	Type II			330 mm/13"		
	М3	3000	Bulk case acc. IEC 60286-6	-	-	-		
SMM0204 EN803 E0 OMM0204 EN803 E0	B1	1000	Blister tape		4 mm	180 mm/7"		
	В3	3000	acc. IEC 60286-3	8 mm				
	В0	10 000	Type II			330 mm/13"		

Note

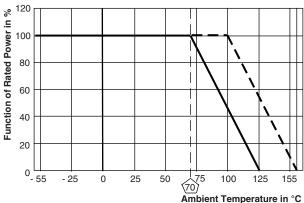
(1) Package of 1000 pieces, code B1, is available only for products with TCR ± 25 ppm/K or ± 15 ppm/K, and with tolerance ± 0.25 % or ± 0.1 %.



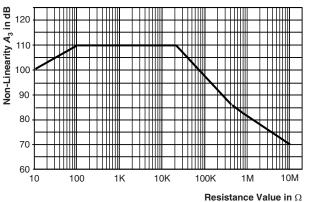
FUNCTIONAL PERFORMANCE



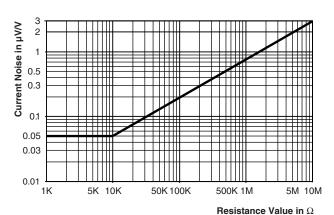
Temperature Rise



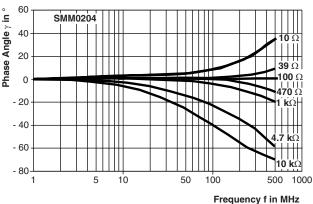
Derating



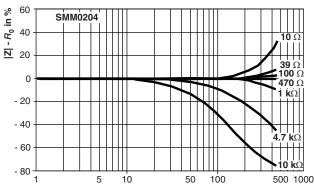
Non-linearity



Current Noise



HF - Performance



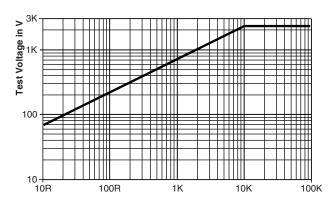
HF - Performance

Frequency f in MHz

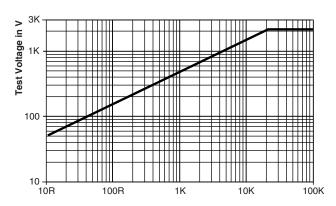
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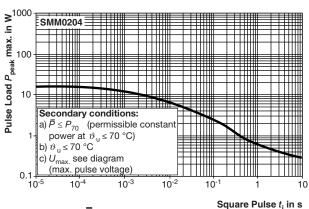
FUNCTIONAL PERFORMANCE



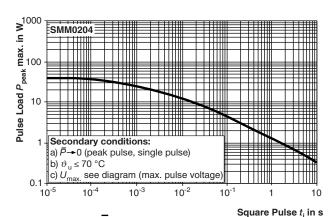
Resistance Value in Ω Single pulse high voltage overload capability 1.2/50 acc. EN 60115-1, 4.27



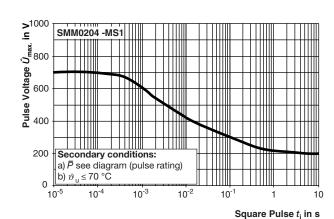
Resistance Value in $\boldsymbol{\Omega}$ Single pulse high voltage overload capability 10/700 acc. EN 60115-1, 4.27



Pulse Rating $\bar{P} \le P_{70}$



Pulse Rating $\bar{P} \longrightarrow 0$



Maximum Pulse Voltage



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TEST PROCEDURES AND REQUIREMENTS								
		REQUIREMENTS PERMISSIBLE CHANGE (ΔR)						
TEST	CONDITIONS OF TEST	STABILITY CLASS 0.25	STABILITY CLASS 0.5	STABILITY CLASS 1	STABILITY CLASS 2			
		10 Ω to 332 k Ω	1 Ω to 10 Ω	< 1 Ω	> 332 kΩ			
Endurance test at 70 °C	$U = \sqrt{P_{70} \times R} \le U_{\text{max.}};$ 1.5 h "on", 0.5 h "off"							
IEC 60115-1, 4.25.1	at 70 °C, 1000 h	± (0.25 %	$R + 0.05 \Omega$		± (0.5 % R + 0.05 Ω)			
	at 70 °C, 8000 h	± (0.5 %	$R + 0.05 \Omega$)		± (1.0 % R + 0.05 Ω)			
Endurance at UCT IEC 60115-1, 4.25.3	at 125 °C, 1000 h	± (0.25 % R + 0.05 Ω)		± (0.5 % R + 0.05 Ω)				
Damp heat steady state 40 °C/93 % RH IEC 60115-1, 4.24 and IEC 60068-2-78	56 days; $U = 0.1 \times \sqrt{P_{70} \times R}$; $U_{\text{max.}} = 20 \text{ V}$	\pm (0.25 % R + 0.05 Ω) \pm (0.5 % R + 0.05 Ω)			0.05 Ω)			
Damp heat steady state accelerated 85 °C/85 % RH	1000 h; $U = 0.3 \times \sqrt{P_{70} \times R}$; $U_{\text{max.}} = 40 \text{ V}$		± 1.0 % <i>R</i> +	0.05 Ω) ⁽¹⁾				
Rapid change of temperature; 1000 cycles IEC 60115-1, 4.19 and IEC 60068-2-14	30 min at LCT; 30 min at UCT; LCT = - 55 °C; UCT = 125 °C	± (0.25 % R + 0.05 Ω)						
Overload test IEC 60115-1, 4.13	$U = 2.5 \text{ x } \sqrt{P_{70} \text{ x } R} \le 2 \text{ x } U_{\text{max.}};$	$\pm (0.05 \% R + 0.01 \Omega)$ $\pm (0.1 \% R -$		± (0.1 % R + 0.05 Ω)				
Electrostatic discharge (HBM) IEC 60340-3-1	3 positive + 3 negative discharges 2 kV	± (1) 5 % D ± (1) (1) (1)						
Resistance to soldering heat IEC 60115-1, 4.18.2 and IEC 60068-2-58	Solder bath method (260 ± 5) °C; 10 s	$\pm (0.05 \% R + 0.01 \Omega)$ $\pm (0.1 \% R + 0.05 \Omega)$		- 0.05 Ω)				

Note

APPLICABLE SPECIFICATIONS

• EN 60115-1 Generic specification • EN 140400 Sectional specification • EN 140401-803 Detail specification • IEC 60068-2-x Variety of environmental test procedures • IEC 60286-3 Packaging of SMD components

 $^{^{(1)}}$ For resistance > 2M21: ± (2.0 % R + 0.05 $\Omega).$



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